IPC ASSOCIATION ELECTRONIC	Material Compo © Copyright 2005. IF cs INDUSTRIES® international and Pan	PC, Bannockb	urn, Illinois. A	all rights reserved untions.	nder both	This docume level parts, t	ent is a decla the declaration	ration on enco	of the substances ompasses all lowe	within the r level ma	e manufactur terials for w	rer listed it hich the m	em. Note: nanufacture	if the item is an as er has engineering	ssembly with lowe responsibility.	
1752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materia					als and M	als and Mfg Information					
Supplie	r Information															
Company name* Company unic				ique ID [			Unique ID Authority					Response Date*				
onsemi													2024-04-29			
Contact N	Vame	Title - Contact				Phone - Contact*				Email - Contact*						
Product-l	Env-Stewards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
Authorize	ed Representative*	Title - Representative				Phone - Representative*				Email - Representative*						
Product-l	Env-Stewards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
	Requester Item Number Mfr Item		Number Mfr Item Name				Effective D	ate V	Version Manufacturing Site		ring Site	1	Weight*	UOM	Unit Type	
		NCV33064P-5RAG		ANA UNDER 5V SENSE CRKT			2024-04-29	,		CNM		1	198.01	mg	Each	
Manufa	acturing Proccess Informat	ion					•		1							
	Terminal Plating / Grid Array Material T		Cerminal Base Alloy J-STD-020 MS		-STD-020 MSI	_ Rating	Peak Process Body Temperat		ure Max Time at Peak Temper		Temperat	ure Num	ber of Reflow Cyc	eles		
	Matte Tin (Sn) - annealed		CU Alloy NA			0 C		30		seconds 3						
Comments	S			·							·				·	
or more	information regarding material	composition	please refer to	page 3		· · · · · · · · · · · · · · · · · · ·										

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
cadmium, hexavalentchromium, polybromin contains a RoHS restricted substance inexce encompass all such components. Supplier cet as of the date that Supplier completes this Company acknowledges that Supplier may hindependently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated diphess of an applicable quantity limit, please indriffes that it gathered the information it provom. Supplier acknowledges that Company wave relied on informationprovided by others of the supplier agrees that, at a minimusy and the Supplier enter into a written agree yesource of the Supplier's liability and the C	enyl ethers (each a "RoHS restricted substan licate below which, if any, RoHS exemption vides in this form using appropriate methods vill rely on this certification in determining the s in completing this form, and that Supplier um, itssuppliers have provided certifications ement with respect to the identified part, the tompany's remedies for issues that arise rega	s of the European Union member states) of the ce") in excess of the applicable quantity limit is you believe may apply. If the part is an assemb to ensure its accuracy and that such informatio e compliance of its products with European Ur may not have independently verified such infor regarding their contributions to the part, and the erms and conditions of that agreement, including information the Supplier provides in this	dentified above. If a ally with lower level in is true and correct tion member state la mation. However, in ose certifications are ag any warranty righ	homogeneous material within the part components, the declaration shall to the best of its knowledge and belief, was that implement the RoHS Directive. In situations where Supplier has not the at least as comprehensive as the lats and/or remedies provided as part of						
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

<b>Homogeneous Material</b>	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	3.2	mg	Supplier	Silicon (Si)	7440-21-3		3.2	mg
Die Attach	5.15	mg	Supplier	Silver (Ag)	7440-22-4		3.8625	mg
			Supplier	Epoxy resins	129915-35-1		1.2875	mg
Lead Frame	80.67	mg	Supplier	Silver (Ag)	7440-22-4		0.4033	mg
			Supplier	Copper (Cu)	7440-50-8		80.2666	mg
Mold Compound-Black	106.15	mg		Metal Hydroxide	proprietary data		5.3075	mg
			Supplier	Carbon Black (C)	1333-86-4		1.0615	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		79.6125	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		10.615	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		9.5535	mg
Plating	2.74	mg	Supplier	Tin (Sn)	7440-31-5		2.74	mg
Wire Bond - Au	0.1	mg	Supplier	Gold (Au)	7440-57-5		0.1	mg